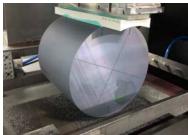
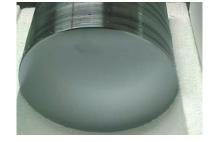


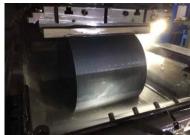


DS 261









12" WAFER WITH HIGHEST SURFACE QUALITY

- Compact and solid construction
- High thermal and vibration stability
- Lowest warp, waviness and TTV values
- Excellent results in nano-topology

PRECISE SLURRY WIRE SAW FOR HIGH END INDUSTRIES





HIGHLIGHTS DS 261

- New operator guided HMI and electrical system on Series 6 release
- Wide range of applications: silicon, quartz, gallium arsenide and other hard & brittle material in different dimensions
- Proven slurry technology and DW ready
- Optimized slurry temperature control
- 60-step recipe enables optimal process tuning
- Automated cutting process and perfect accessability
- Optional work piece orientation







Perfect alignment for highest precision



Easy operation for higher yield

TECHNICAL DATA	DS 261 FEATURES
Web length [mm]	410
Max. work piece dimensions [mm]	Ø 305 mm × 400 (Ø 18" on request)
Wire speed [m/s]	15 (900 m/min)
Wire acceleration [m/s²]	2.5 (< 6.5 s)
Min. wire diameter [µm]	120
Max. wire tension [N]	50
Wire guide roller axes distance [mm]	600
Cutting fluid	Slurry
Slurry tank [I]	175
Machine dimensions [L × W × H] [mm]	2980 × 4120 × 3340
Machine weight [kg]	12000

GET IN TOUCH WITH US TODAY

TOGETHER WE WILL FIND A SOLUTION FOR YOUR REQUIREMENTS

PRECISION SURFACING SOLUTIONS GMBH

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